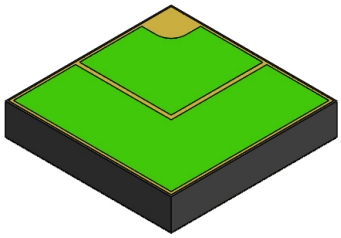
LA SG40WP4

Premium Edition Standard Green 40 mil

LIGHT AVENUE
A Brand of Chips 4 Light GmbH

Light Avenue Premium Edition LED series is designed for high performance consumer applications. Remarkable light extraction is reached by a particular top emitting design with vertical chip structure. As this die can be driven at very high currents compared to the chip size, an outstanding cost vs. performance ratio can be obtained.



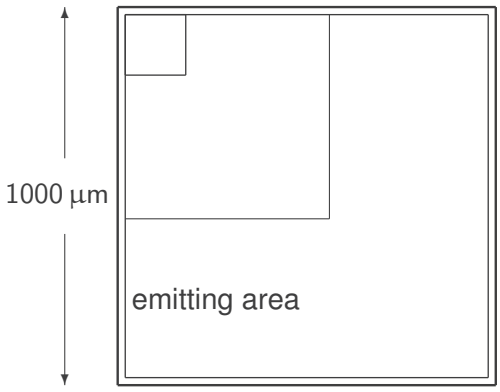
Features

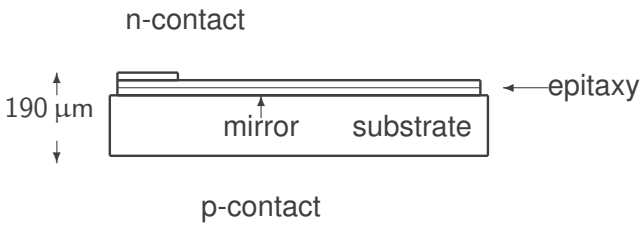
- Highest brightness InGaN chip
- Top emitting device
- Lambertian radiation
- Optimized for SMT applications
- Grouping: luminous intensity, wavelength

Applications

- Solid state lighting
- LCD backlighting
- Lamps
- Displays
- Light indicators

Delineation





Mechanical characteristics

DESCRIPTION		MINIMUM	TYPICAL[1]	MAXIMUM
Chip size	(µm)	950	1000	1050
Chip height	(µm)	170	190	210
Bond pad diameter	(µm)	160	180	200
Top contact		Cathode (n), gold		
Bottom contact		Anode (p), gold alloy		
Die attach		Epoxy bonding		

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Electro-optical characteristics ($T_A = 25°C$)[2]

PARAMETER	SYMBOL	CONDITION	MIN.	TYP.[1]	MAX.	UNIT
Forward voltage	V_F	$I_F = 350\,mA$	2.70		3.80	V
Reverse voltage	V_R	$I_R = 10\,\mu A$	5			V
Dominant wavelength	λ_{dom}	$I_F = 350\,mA$	515		537.5	nm
Luminous intensity	I_v	$I_F = 350\,mA$	12500	25000		mcd

Maximum ratings ($T_A = 25°C$)[3]

PARAMETER	SYMBOL	VALUE	UNIT
Operating temperature range	T_{op}	-40...85	°C
Forward current	I_F	700	mA
Pulse current	I_P	1500	mA
Junction temperature	T_j	125	°C

Binning ($I_F = 350\,mA$)

	WAVELENGTH (NM)							
	515-520	517.5-522.5	520-525	522.5-527.5	525-530	527.5-532.5	530-535	532.5-537.5
> 12500	A48	AM48	B48	BM48	C48	CM48	D48	DM48
> 16000	A49	AM49	B49	BM49	C49	CM49	D49	DM49
Luminous intensity (mcd) > 20000	A50	AM50	B50	BM50	C50	CM50	D50	DM50
> 25000	A51	AM51	B51	BM51	C51	CM51	D51	DM51
> 32000	A52	AM52	B52	BM52	C52	CM52	D52	DM52
> 40000	A53	AM53	B53	BM53	C53	CM53	D53	DM53

There may be more than one bin on one single foil. Single bins cannot be ordered. Customized specifcations are possible. Please contact our nearest sales office for further information.

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Handling and Storage Conditions

Storage time for wafers in sealed condition is not limited by the die itself, but may be limited by the adhesion of the blue foil (storage ambient conditions: $T_a = 15 \ldots 30°C$; relative humidity: < 60%, vertical storage). Therefore we ship the dice without any limitation of shelf life. Customer has to make sure that there is no glue from the adhesive foil on the backside either by a die shear test or by visual inspection of the backside before production. The hermetically sealed shipment lot shall be opened under temperature and moisture controlled cleanroom environment only. Customers have to follow the according rules for desposition as the material can be hazardous for humans and the environment. Dice have to be handled ESD sensitive.

Packing

Chips are placed on a blue foil inside a 6 inch ring or alternatively on a blue foil (mylar) only. For shipment the wafers of a shipment lot are arranged to stacks. Please use the recycling operators familiar to you. If required you can ask for our help. Please get in touch with your nearest sales office. By agreement we will take packing material back, if sorted. Transport costs of any kind must be paid by customers. For packing material that is returned to us unsorted or which we are not obliged to accept, any costs incurred will be invoiced to you.

Design Objectives

The chip design was developed and released based on the producer's standard assembly procedures and packaging. Bond strength properties are in accordance to MIL-STD-750D, method 2037. Whether the chip fits to the customer's products with its according die and wire bond procedures and packaging must be evaluated by the customer himself. If workability problems arise after this release a mutually conducted problem solving procedure has to be set up, if the chips are suspected of contributing to the problems.The chips are produced with best effort, but on chip level a subset of the chip characteristics can be determined only. Performance of the chip in the customer's products can only be determined by the customer himself.

Returns and Complaints

For complaints and returns of material a RMA-number is necessary. Samples for analysis purposes can be send to us without credit.

Shipping Conditions

If not otherwise arranged, the "General Terms of Business of Chips 4 Light GmbH" apply for any shipment. If this document is not familiar to you, please request it at our nearest sales office.

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- The information describes the type of component and shall not be considered as assured characteristics. Due to technical requirements components may contain dangerous substances. For information on the types in question please contact our Sales Organization.
- Lead free product - RoHS compliant.
- The quality level of the final visual inspection shall comply to an AQL of 1.0 (according to MIL-STD-105E, level II), if the customer performes an incoming visual inspection of a shipment.

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- All chips are checked according to the producer's specification of the visual inspection. If this document is not familiar to you, please request it at our nearest sales office.

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[1]Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

[2]Measurements are done with an accuracy of $\pm$15%. Correlation to customer's equipment and products is required.

[3]Maximum ratings are package dependent and may differ between packages. The forward current is not limited by the die but by the effect of the LED junction temperature on the package. If you need more information on pulsed operation, please contact your next sales office about possible driving conditions. If not otherwise specified the maximum pulse current may not exceed the maximum current in continuous mode.

[4]A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.

[5]Life support devices or systems are intended(a) to be implanted in the human body,or(b) to support and/or maintain and sustain human life.If they fail, it is reasonable to assume that the health and the life of the user may be endangered..

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